



Material Composition Declaration

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This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.

Adobe Reader version 7.0.5 is required to complete this declaration.

1752-2 1.1	IPC Web Site for Information on IPC-1752 Standard http://www.ipc.org/IPC-175x	Form Type * Distribute	Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materials and Mfg Informat
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Supplier Information

Company Name * Cypress Semiconductor Corp	Company Unique ID CYPRESS	Unique ID Authority	Response Date * 2020-05-10	Response Document ID				
Contact Name * QA Customer Support	Title - Contact QA Customer Support	Phone - Contact * +6328497500	Email - Contact * qacs_team@cypress.com	Duplicate Contact -> Authorized Representative				
Authorized Representative * Jeff Gary Balleca	Title - Representative STAFF EHS Engr	Phone - Representative * +6328497500	Email - Representative * jgtb@cypress.com	Supplier Comments or URL for Additional Information http://app.cypress.com/portal/server.pt?space=Community				
Requester Item Number	Mfr Item Number	Mfr Item Name	Effective Date	Version	Manufacturing Site	Weight *	UOM	Unit Type
QFN_LT56_8 X 8 mm	QFN_LT56_8 X 8 mm	QFN_LT56_8 X 8 mm	2020-05-10		CML	165.2401	mg	Each
Alternate Recommendation				Alternate Item Comments	Package QTP No. 092006			

Manufacturing Process Information

Terminal Plating / Grid Array Material Nickel/Palladium/Gold (Ni/Pd/Au)	Terminal Base Alloy CU Alloy	J-STD-020 MSL Rating 3	Peak Process Body Temperature 260 C	Max Time at Peak Temperature 30 seconds	Number of Reflow Cycles 3
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Comments

TEST REPORT: MC (001-79656) ; DA (001-79588) ; PLATING (001-80096) ; BW (001-79691) ; LF (001-80096)

Save the fields in this form to a file

Export Data

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Import Data

Clear all of the fields on this form

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Lock the fields on this form to prevent changes

Lock Supplier Fields

RoHS Material Composition Declaration

Declaration Type *

Detailed

RoHS Directive 2002/95/EC **RoHS Definition:** Quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury, Hexavalent Chromium, Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE) and quantity limit of 0.01% by mass (100 PPM) of homogeneous material for Cadmium

Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2002/95/EC and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalent chromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance in excess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its suppliers have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies provided as part of that agreement, will be the sole and exclusive source of the Supplier's liability and the Company's remedies for issues that arise regarding information the Supplier provides in this form. In the absence of such written agreement, the warranty rights and/or remedies of Supplier's Standard Terms and Conditions of Sale applicable to such part shall apply.

RoHS Declaration *

1 - Item(s) does not contain RoHS restricted substances per the definition above

Supplier Acceptance *

Accepted

Exemptions: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.

Declaration Signature

Instructions: Complete all of the required fields on all pages of this form. Select the "Accepted" on the Supplier Acceptance drop-down. This will display the signature area. Digitally sign the declaration (if required by the Requester) and click on Submit Form to have the form returned to the Requester.

Supplier Digital Signature

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Line Functions: +I Inserts a New Item /SubItem +M Inserts a new Material +C Inserts a new Substance Category +S Inserts a new Substance - Deletes the element line

		Item/SubItem Name		Homogeneous Material		Weight	Unit of Measure	Level		Substance Category		Substance		CAS	Exempt	Weight	Unit of Measure	Tolerance		PPM		
																		-	+			
+I	-I	Base Material		+M	-M	Leadframe	56.53	mg	+C	-C	Supplier	Cu	+S	-S	Cu	7440-50-8		55.0659	mg			333,24
									+C	-C	Supplier	Fe	+S	-S	Fe	7439-89-6		1.3567	mg			8,211
									+C	-C	Supplier	P	+S	-S	P	7723-14-0		0.0396	mg			239
									+C	-C	Supplier	Zn	+S	-S	Zn	7440-66-6		0.0678	mg			411
+I	-I	External Plating		+M	-M	Leadfinish	0.89	mg	+C	-C	B	Nickel (external applic	+S	-S	Nickel	7440-02-0		0.859	mg			5,199
									+C	-C	Supplier	Pd	+S	-S	Pd	7440-05-3		0.0155	mg			94
									+C	-C	Supplier	Au	+S	-S	Au	7440-57-5		0.0155	mg			94
+I	-I	Adhesive		+M	-M	Die Attach	0.44	mg	+C	-C	Supplier	Silver	+S	-S	Silver	7440-22-4		0.3256	mg			1,970
									+C	-C	Supplier	Carbocyclic Acrylate	+S	-S	Carbocyclic Acrylate	Trade Secre		0.088	mg			533
									+C	-C	Supplier	Bismaleimide Resin	+S	-S	Bismaleimide Resin	Trade Secre		0.0088	mg			53
									+C	-C	Supplier	Additive	+S	-S	Additive	Trade Secre		0.0088	mg			53
									+C	-C	Supplier	Acrylate Ester	+S	-S	Acrylate Ester	Trade Secre		0.0088	mg			53
+I	-I	Circuit		+M	-M	Die	5.97	mg	+C	-C	Supplier	Silicon	+S	-S	Silicon	7440-21-3		5.97	mg			36,129
+I	-I	Interconnect		+M	-M	Wire	4.84	mg	+C	-C	Supplier	Au	+S	-S	Au	7440-57-5		4.7916	mg			28,998
									+C	-C	Supplier	Pd	+S	-S	Pd	7440-05-3		0.0484	mg			293
+I	-I	Encapsulation		+M	-M	Mold Compound	96.5701	mg	+C	-C	Supplier	Silica Fused	+S	-S	Silica Fused	60676-86-0		80.636	mg			487,99
									+C	-C	Supplier	Metal OH	+S	-S	Metal OH	1309-42-8		2.8971	mg			17,533
									+C	-C	Supplier	Phenol Resin	+S	-S	Phenol Resin	Trade Secre		3.8628	mg			23,377
									+C	-C	Supplier	Epoxy Resin	+S	-S	Epoxy Resin	Trade Secre		3.8628	mg			23,377
									+C	-C	Supplier	Carbon Black	+S	-S	Carbon Black	1333-86-4		0.4829	mg			2,922
									+C	-C	Supplier	Crystalline Silica	+S	-S	Crystalline Silica	14808-60-7		4.8285	mg			29,221